

## APPLICATION DATA SHEET

**Application Information**

Application Type::	Regular
Subject Matter::	Utility
Title::	SEMICONDUCTOR SUBSTRATE, SEMICONDUCTOR DEVICE AND PROCESS FOR PRODUCING SEMICONDUCTOR SUBSTRATE
Attorney Docket No::	60562.00009
Total Drawing Sheets::	19
Request for Early Publication?::	No
Request for Non-Publication?::	No
Small Entity::	Yes
Secrecy Order in Parent Appln?::	No

**Applicant Information**

Applicant Authority Type::	Inventor
Citizenship Country::	Japan
Status::	Full Capacity
Given Name::	Tetsushi
Middle Name::	
Family Name::	SAKAI
City of Residence::	Yokohama
State or Province of Residence::	
Country of Residence::	Japan
Street of Mailing Address::	c/o Tokyo Institute of Technology 4259, Nagatsuta-cho, Midori-ku

City of Mailing Address:: Yokohama-shi  
State or Province of Mailing Address:: Kanagawa  
Country of Mailing Address:: Japan  
Postal or Zip Code of Mailing Address:: 226-8503

Applicant Authority Type:: Inventor  
Citizenship Country:: Japan  
Status:: Full Capacity  
Given Name:: Shunichiro  
Middle Name::  
Family Name:: OHMI  
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Street of Mailing Address:: c/o Tokyo Institute of Technology  
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City of Mailing Address:: Yokohama-shi  
State or Province of Mailing Address:: Kanagawa  
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Applicant Authority Type:: Inventor  
Citizenship Country:: Japan  
Status:: Full Capacity  
Given Name:: Takashi  
Middle Name::  
Family Name:: YAMAZAKI  
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State or Province of Residence::  
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**Correspondence Information**

Correspondence Customer Number:: 32294

**Representative Information**

Representative Customer Number:: 32294

**Domestic Priority Information**

Application::	Continuity Type::	Parent Application::	Parent Filing Date::
This Application	National Stage of	PCT/JP2004/014603	10/04/04

**Foreign Priority Information**

Country:: Japan  
Application No:: 2003-352692  
Filing Date:: 10/10/03  
Priority Claimed:: Yes

**Assignment Information**

Assignee Name::

TOKYO INSTITUTE OF TECHNOLOGY